



JAE Electronics, Inc.
August 3rd, 2026

ENG-E26-107 - Distributors

PCN (Process Change Notice)
MX80B03PZ1A
Rear Cover Additional Mold Die (C,D,E,F)
To Keep Production Capacity
(#296)

Part Number	Rear Cover Existing Mold Die with 2 cavities	Rear Cover Additional Mold Die created with 4 cavities	Completion of Rear Cover Additional Mold Die	Proposed PPAP Submission	Start of Mass Production (SOP)
MX80B03PZ1A	#621960-001 (A,B)	#622572-001 (C,D,E,F) Will be created	September 2026	April 2027	After receiving approvals from all customers

Notes:

- PC = Process Change (Tooling: Transfer, Replacement, Refurbishment, or additional and Parts Produced at Additional Location, etc...)
 - PPAP = Production Part Approval Process
1. PC PPAP will only be prepared and provided to customer who already requested and received initial PPAP.
 2. If you request PC PPAP documents for this notification, please notify us ASAP.